



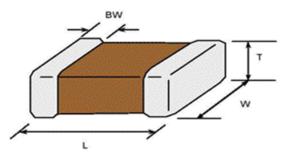
SPECIFICATION

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL02A104MQ2NNNC
- Description : CAP, 100 nF, 6.3V, ±20%, X5R, 01005

A. Samsung Part Number

		<u>CL</u> 02 ① ②			<u>n</u> 9 10	<u>C</u> 10
1	Series	Samsung Multi-layer Ceramic Capacitor				
2	Size	01005 (inch code) L: 0.4	40 ± 0.02 mm	W:	0.20 ± 0.02 mm
3	Dielectric	X5R	(Inner electrode		Ni
4	Capacitance	100 nF		Termination		Cu
5	Capacitance	±20 %		Plating		Sn 100% (Pb Free)
	tolerance			Product		Normal
6	Rated Voltage	6.3 V	Ó	O Special		Reserved for future use
1	Thickness	0.20 ± 0.02 mn	า (โ	D Packaging		Cardboard type, 7" reel

B. Structure and dimension



Samsung P/N	Dimension(mm)					
	L	W	Т	BW		
CL02A104MQ2NNNC	0.40±0.02	0.20±0.02	0.20±0.02	0.10±0.03		

C. Samsung Reliability Test and Judgement condition

	Performance	Test condition		
Capacitance	Within specified tolerance	1kl±±10% 0.5±0.1Vrms *A capacitor prior to measuring the capacitance is heat treated at 150℃+0/-10℃ for 1 hour and maintained in		
Tan δ (DF)	0.125 max.	ambient air for 24±2 hours.		
Insulation	10,000Mohm or 10Mohm ·µF	Rated Voltage 60~120 sec.		
Resistance	Whichever is smaller			
Appearance	No abnormal exterior appearance	Microscope (×20)		
Withstanding	No dielectric breakdown or	250% of the rated voltage		
Voltage	mechanical breakdown			
Temperature X5R		•		
Characteristics	(From -55℃ to 85℃, Capacitance chang	ge should be within ±15%)		
Adhesive Strength	No peeling shall be occur on the	100g·F, for 10±1 sec.		
of Termination	terminal electrode			
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)		
		with 1.0mm/sec.		
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder		
	is to be soldered newly	245±5℃, 3±0.3sec.		
		(preheating : 80~120 ℃ for 10~30sec.)		
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.		
Soldering heat	Tan δ, IR : initial spec.			
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm		
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)		
		2hours \times 3 direction (x, y, z)		
Moisture	Capacitance change : within ±12.5%	With rated voltage		
Resistance	Tan δ : 0.25 max	40±2℃, 90~95%RH, 500+12/-0hrs		
	IR : 500Mohm or 0.5Mohm $\cdot \mu F$			
	Whichever is smaller			
High Temperature	Capacitance change : within ±12.5%	With 150% of the rated voltage		
Resistance	Tan δ : 0.25 max	Max. operating temperature		
	IR : 1,000Mohm or 0.5Mohm · <i>µ</i> F			
	Whichever is smaller	1000+48/-0hrs		
Temperature	Capacitance change : within ±15%	1 cycle condition		
Cycling	Tan δ, IR : initial spec.	Min. operating temperature \rightarrow 25 °C		
		\rightarrow Max. operating temperature \rightarrow 25 °C		
		5 cycle test		

* The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260±5 °C, 30sec.)

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.

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- ② Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- *④ Military equipment*
- *5* Disaster prevention/crime prevention equipment
- *ⓐ* Any other applications with the same as or similar complexity or reliability to the applications set forth above.

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